

BUK7909-75AIE

N-channel TrenchPLUS standard level FET

Rev. 02 — 17 February 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. The devices include TrenchPLUS current sensing and diodes for ElectroStatic Discharge (ESD) protection. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- Electrostatically robust due to integrated protection diodes
- Low conduction losses due to low on-state resistance
- Q101 compliant

1.3 Applications

 Electrical Power Assisted Steering (EPAS)

1.4 Quick reference data

Table 1. Quick reference

- Reduced component count due to integrated current sensor
- Suitable for standard level gate drive sources
- Variable Valve Timing for engines

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	75	V
I _D	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C};$ see <u>Figure 2</u> ; see <u>Figure 3</u>	[1]	-	-	120	A
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	$\label{eq:GS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 50 \text{ A}; \\ T_{j} = 25 \text{ °C}; \text{ see } \underline{\text{Figure 7}}; \\ \text{see } \underline{\text{Figure 8}} \end{array}$		-	8	9	mΩ
I _D /I _{sense}	ratio of drain current to sense current	T _j > -55 °C; T _j < 175 °C; V _{GS} > 10 V		450	500	550	

[1] Current is limited by power dissipation chip rating.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		d
2	ISENSE	sense current	mb	, , , , , , , , , , , , , , , , , , ,
3	D	drain		
4	KS	Kelvin source		
5	S	source		g / t
mb	D	mounting base; connected to drain		MBL368 Isense Kelvin source
			SOT263B	

3. Ordering information

Table 3. Ordering information

Type number			
	Name	Description	Version
BUK7909-75AIE	TO-220	plastic single-ended package; heatsink mounted; 1 mounting hole; 5-lead TO-220	SOT263B

(TO-220)

4. Limiting values

Table 4. Limiting values

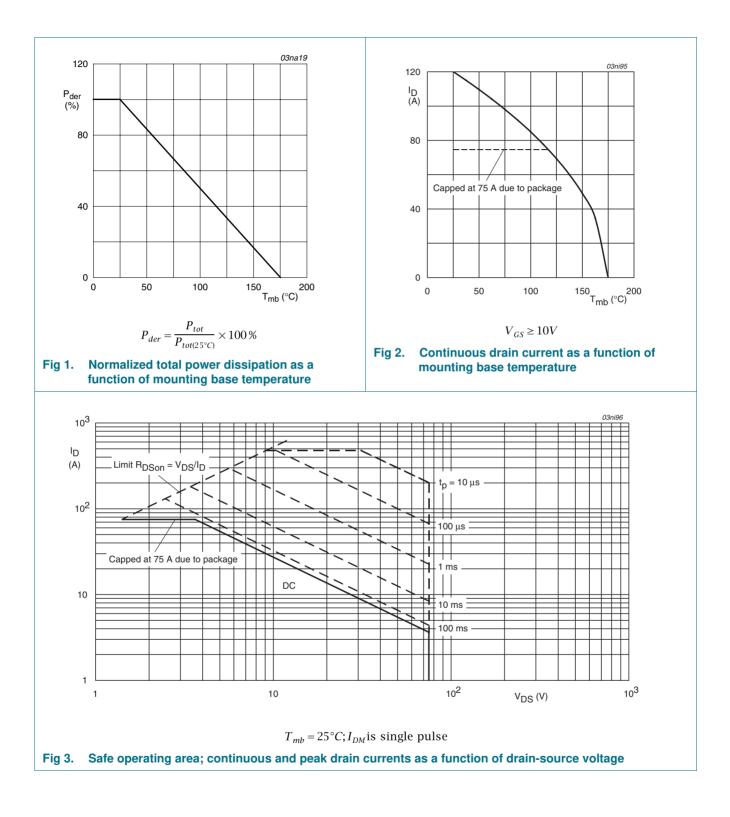
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	75	V
V _{DGS}	drain-gate voltage			-	75	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 2}}{\text{Figure 3}}; \text{ see } \frac{\text{Figure 3}}{\text{Figure 3}}$	[1]	-	120	А
			[2]	-	75	А
		T _{mb} = 100 °C; V _{GS} = 10 V; see <u>Figure 2</u>	[2]	-	75	А
I _{DM}	peak drain current	$T_{mb} = 25 \text{ °C}; t_p \le 10 \mu\text{s}; \text{ pulsed}; \text{ see } \frac{\text{Figure 3}}{10 \mu\text{s}}$		-	480	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 1</u>		-	272	W
I _{GS(CL)}	gate-source clamping	continuous		-	10	mA
	current	pulsed; $t_p = 5 \text{ ms}; \delta 0.01$		-	50	mA
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C	[1]	-	120	А
			[2]	-	75	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	480	А
Avalanche	ruggedness					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$ I_D = 75 \text{ A}; \text{V}_{sup} \leq 75 \text{ V}; \text{R}_{GS} = 50 \Omega; \text{V}_{GS} = 10 \text{ V}; \\ \text{T}_{j(\text{init})} = 25 ^\circ\text{C}; \text{ unclamped} $		-	739	mJ
Electrosta	tic discharge					
V _{esd}	electrostatic discharge voltage	HBM; C = 100 pF; R = 1.5 k Ω		-	6	kV

[1] Current is limited by power dissipation chip rating.

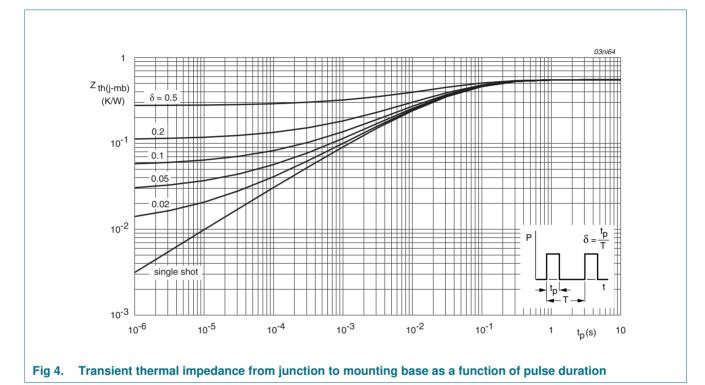
[2] Continuous current is limited by package.

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5. Thermal characteristics

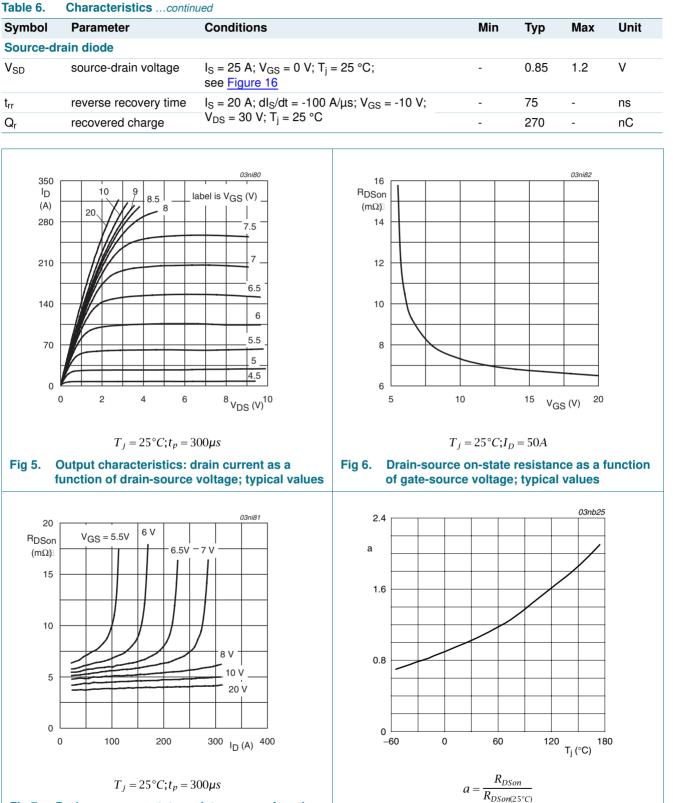
Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <u>Figure 4</u>	-	-	0.55	K/W



6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _{(BR)DSS}	drain-source	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	75	-	-	V
	breakdown voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{V}; T_j = -55 ^\circ\text{C}$	70	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 9	2	3	4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see Figure 9	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 9	-	-	4.4	V
I _{DSS}	drain leakage current	V_{DS} = 75 V; V_{GS} = 0 V; T_j = 25 °C	-	0.1	10	μA
		$V_{DS} = 75 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	250	μA
V _{(BR)GSS}	gate-source breakdown voltage	$I_G = 1 \text{ mA}; V_{DS} = 0 \text{ V}; T_j > -55 \text{ °C}; T_j < 175 \text{ °C}$	20	22	-	V
		I _G = -1 mA; V _{DS} = 0 V; T _j > -55 °C; T _j < 175 °C	20	22	-	V
I _{GSS}	gate leakage current	$V_{DS} = 0 V; V_{GS} = 10 V; T_j = 25 \ ^{\circ}C$	-	22	1000	nA
		$V_{DS} = 0 V; V_{GS} = -10 V; T_j = 25 \text{ °C}$	-	22	1000	nA
		$V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}; T_j = 175 \text{ °C}$	-	-	10	μA
		$V_{DS} = 0 V; V_{GS} = -10 V; T_j = 175 \ ^{\circ}C$	-	-	10	μA
DOON	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A}; T_j = 25 \text{ °C};$ see <u>Figure 7</u> ; see <u>Figure 8</u>	-	8	9	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 50 \text{ A}; T_j = 175 \text{ °C};$ see <u>Figure 7</u> ; see <u>Figure 8</u>	-	-	19	mΩ
I _D /I _{sense}	ratio of drain current to sense current	V _{GS} > 10 V; T _j > -55 °C; T _j < 175 °C	450	500	550	
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 60 \text{ V}; V_{GS} = 10 \text{ V};$	-	121	-	nC
Q _{GS}	gate-source charge	T _j = 25 °C; see <u>Figure 14</u>	-	20	-	nC
Q _{GD}	gate-drain charge		-	44	-	nC
C _{iss}	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$	-	4700	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 12</u>	-	800	-	pF
C _{rss}	reverse transfer capacitance		-	455	-	pF
t _{d(on)}	turn-on delay time	$V_{DS} = 30 \ V; \ R_L = 1.2 \ \Omega; \ V_{GS} = 10 \ V;$	-	35	-	ns
t _r	rise time	$R_{G(ext)} = 10 \ \Omega; T_j = 25 \ ^{\circ}C$	-	108	-	ns
t _{d(off)}	turn-off delay time		-	185	-	ns
t _f	fall time		-	100	-	ns
L _D	internal drain inductance	measured from upper edge of drain mounting base to centre of die; $T_j = 25 \text{ °C}$	-	2.5	-	nH
L _S	internal source inductance	measured from source lead to source bond pad; $T_j = 25 \text{ °C}$	-	7.5	-	nH

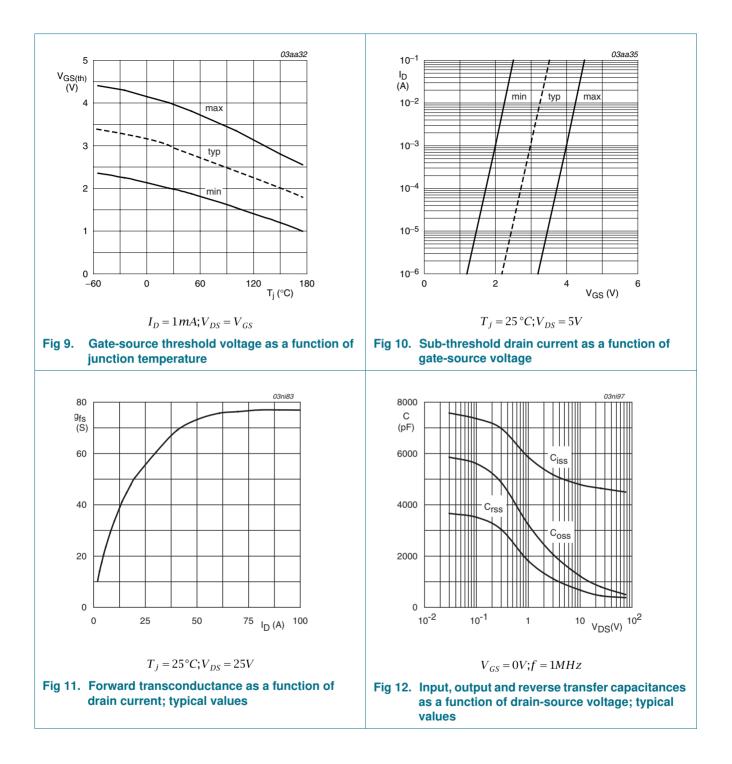
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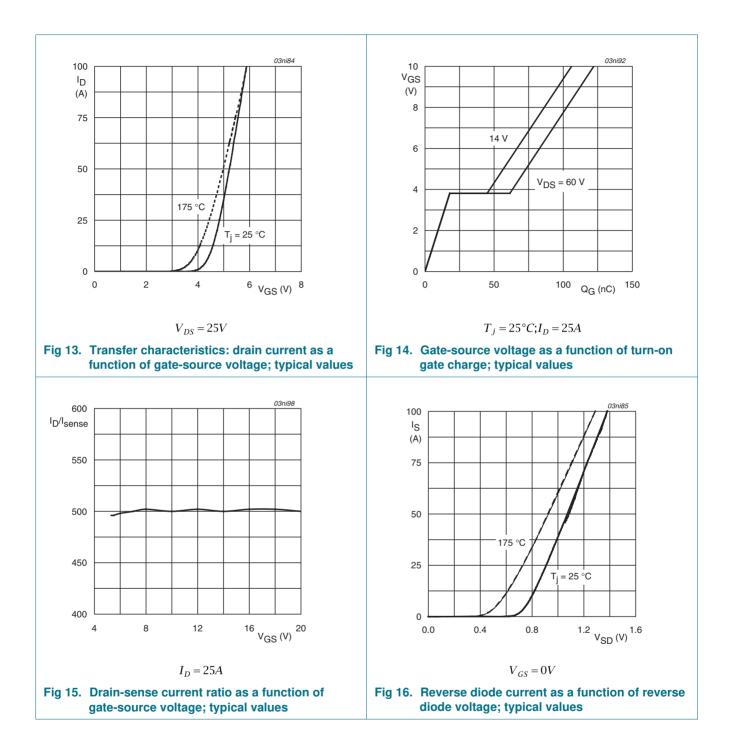




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7. Package outline

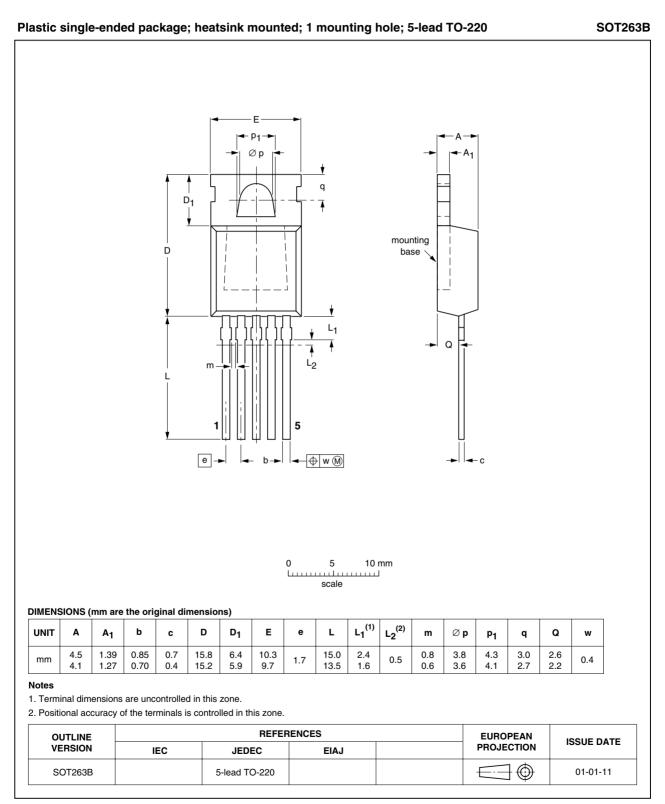


Fig 17. Package outline SOT263B (TO-220)

BUK7909-75AIE_2

8. Revision history

Table 7. Revision hist	ory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK7909-75AIE_2	20090217	Product data sheet	-	BUK71_7909_75AIE-01
Modifications:		of this data sheet has be of NXP Semiconductors.	en redesigned to comply	y with the new identity
	 Legal texts 	have been adapted to th	e new company name w	here appropriate.
	 Type numb 	er BUK7909-75AIE sepa	rated from data sheet Bl	JK71_7909_75AIE-01.
BUK71_7909_75AIE-01 (9397 750 09879)	20020809	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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